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## **Push-Pull Output Sub-Microamp Comparators**

#### Features:

- · Low Quiescent Current: 600 nA/Comparator (typ.)
- Rail-to-Rail Input:  $V_{SS}$  0.3V to  $V_{DD}$  + 0.3V
- CMOS/TTL-Compatible Output
- Propagation Delay: 4 μs (typical, 100 mV Overdrive)
- Wide Supply Voltage Range: 1.6V to 5.5V
- · Available in Single, Dual and Quad
- · Single Available in SOT-23-5, SC-70-5 \* Packages
- Chip Select (CS) with MCP6543
- · Low Switching Current
- Internal Hysteresis: 3.3 mV (typ.)
- Temperature Ranges:
  - Industrial: -40°C to +85°CExtended: -40°C to +125°C

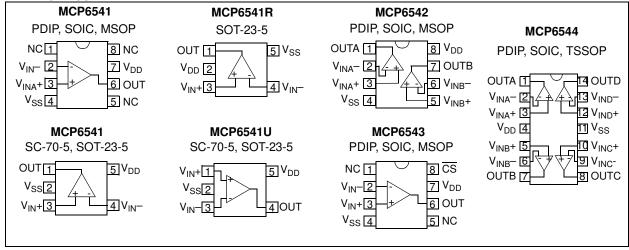
## **Typical Applications:**

- · Laptop Computers
- · Mobile Phones
- · Metering Systems
- · Hand-held Electronics
- RC Timers
- · Alarm and Monitoring Circuits
- Windowed Comparators
- Multivibrators

#### **Related Devices:**

Open-Drain Output: MCP6546/7/8/9

#### **Package Types**



#### **Description:**

The Microchip Technology Inc. MCP6541/1R/1U/2/3/4 family of comparators is offered in single (MCP65<u>41</u>, MCP6541R, MCP6541U), single with Chip Select (CS) (MCP6543), dual (MCP6542) and quad (MCP6544) configurations. The outputs are push-pull (CMOS/TTL-compatible) and are capable of driving heavy DC or capacitive loads.

These comparators are optimized for low-power, single-supply operation with greater than rail-to-rail input operation. The push-pull output of the MCP6541/1R/1U/2/3/4 family supports rail-to-rail output swing and interfaces with TTL/CMOS logic. The internal input hysteresis eliminates output switching due to internal input noise voltage, reducing current draw. The output limits supply current surges and dynamic power consumption while switching. This product family operates with a single-supply voltage as low as 1.6V and draws less than 1  $\mu$ A/comparator of quiescent current.

The related MCP6546/7/8/9 family of comparators from Microchip has an open-drain output. Used with a pull-up resistor, these devices can be used as level-shifters for any desired voltage up to 10V and in wired-OR logic.

\* SC-70-5 E-Temp parts not available at this release of the data sheet.

MCP6541U SOT-23-5 is E-Temp only.

**NOTES:** 

# 1.0 ELECTRICAL CHARACTERISTICS

### **Absolute Maximum Ratings †**

V <sub>DD</sub> - V <sub>SS</sub>	7.0V
Current at Analog Input Pin ( $V_{IN}$ +, $V_{IN}$	±2 mA
Analog Input (V <sub>IN</sub> ) ††V <sub>SS</sub> -	1.0V to V <sub>DD</sub> + 1.0V
All other Inputs and Outputs $\mbox{V}_{\mbox{\footnotesize SS}}$ -	$0.3V \text{ to } V_{DD} + 0.3V$
Difference Input Voltage	V <sub>DD</sub> - V <sub>SS</sub>
Output Short-Circuit Current	Continuous
Current at Input Pins	±2 mA
Current at Output and Supply Pins	±30 mA
Storage Temperature	65°C to +150°C
Maximum Junction Temperature (T <sub>J</sub> )	+150°C
ESD Protection on all Pins (HBM;MM)	4 kV; 400V

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

†† See Section 4.1.2 "Input Voltage and Current Limits"

#### DC CHARACTERISTICS

**Electrical Specifications:** Unless otherwise indicated,  $V_{DD} = +1.6V$  to +5.5V,  $V_{SS} = GND$ ,  $T_A = +25^{\circ}C$ ,  $V_{IN} + = V_{DD}/2$ ,  $V_{IN} - = V_{SS}$ , and  $R_L = 100 \text{ k}\Omega$  to  $V_{DD}/2$  (Refer to Figure 1-3).

V <sub>IN</sub> -= v <sub>SS</sub> , and n <sub>L</sub> = 100 k <sub>2</sub> z to v <sub>DD</sub> /z (neighbor 1-3).									
Parameters	Sym	Min	Тур	Max	Units	Conditions			
Power Supply									
Supply Voltage	$V_{DD}$	1.6	_	5.5	V				
Quiescent Current per comparator	ΙQ	0.3	0.6	1.0	μΑ	I <sub>OUT</sub> = 0			
Input									
Input Voltage Range	$V_{CMR}$	V <sub>SS</sub> -0.3		V <sub>DD</sub> +0.3	V				
Common Mode Rejection Ratio	CMRR	55	70	_	dB	$V_{DD} = 5V$ , $V_{CM} = -0.3V$ to 5.3V			
Common Mode Rejection Ratio	CMRR	50	65	_	dB	$V_{DD} = 5V$ , $V_{CM} = 2.5V$ to 5.3V			
Common Mode Rejection Ratio	CMRR	55	70	_	dB	$V_{DD} = 5V$ , $V_{CM} = -0.3V$ to 2.5V			
Power Supply Rejection Ratio	PSRR	63	80	_	dB	$V_{CM} = V_{SS}$			
Input Offset Voltage	Vos	-7.0	±1.5	+7.0	mV	V <sub>CM</sub> = V <sub>SS</sub> (Note 1)			
Drift with Temperature	$\Delta V_{OS}/\Delta T_{A}$	_	±3	_	μV/°C	$T_A = -40$ °C to $+125$ °C, $V_{CM} = V_{SS}$			
Input Hysteresis Voltage	V <sub>HYST</sub>	1.5	3.3	6.5	mV	V <sub>CM</sub> = V <sub>SS</sub> (Note 1)			
Linear Temp. Co. (Note 2)	TC <sub>1</sub>	_	6.7	_	μV/°C	$T_A = -40$ °C to $+125$ °C, $V_{CM} = V_{SS}$			
Quadratic Temp. Co. (Note 2)	TC <sub>2</sub>	_	-0.035	_	μV/°C <sup>2</sup>	$T_A = -40$ °C to $+125$ °C, $V_{CM} = V_{SS}$			
Input Bias Current	Ι <sub>Β</sub>	_	1	_	pА	$V_{CM} = V_{SS}$			
At Temperature (I-Temp parts)	Ι <sub>Β</sub>	_	25	100	pА	$T_A = +85^{\circ}C, V_{CM} = V_{SS}$ (Note 3)			
At Temperature (E-Temp parts)	Ι <sub>Β</sub>	_	1200	5000	pА	$T_A = +125$ °C, $V_{CM} = V_{SS}$ (Note 3)			
Input Offset Current	I <sub>OS</sub>	_	±1	_	рА	V <sub>CM</sub> = V <sub>SS</sub>			
Common Mode Input Impedance	Z <sub>CM</sub>		10 <sup>13</sup>   4	_	$\Omega    pF$				
Differential Input Impedance	$Z_{DIFF}$		10 <sup>13</sup>   2	_	$\Omega    pF$				

Note 1: The input offset voltage is the center (average) of the input-referred trip points. The input hysteresis is the difference between the input-referred trip points.

- 2: V<sub>HYST</sub> at different temperatures is estimated using V<sub>HYST</sub> (T<sub>A</sub>) = V<sub>HYST</sub> + (T<sub>A</sub> 25°C) TC<sub>1</sub> + (T<sub>A</sub> 25°C)<sup>2</sup> TC<sub>2</sub>.
- **3:** Input bias current at temperature is not tested for SC-70-5 package.
- 4: Limit the output current to Absolute Maximum Rating of 30 mA.

## **DC CHARACTERISTICS (CONTINUED)**

**Electrical Specifications:** Unless otherwise indicated,  $V_{DD} = +1.6V$  to +5.5V,  $V_{SS} = GND$ ,  $T_A = +25$ °C,  $V_{IN} + = V_{DD}/2$ ,  $V_{IN} - = V_{SS}$ , and  $R_L = 100$  kΩ to  $V_{DD}/2$  (Refer to Figure 1-3).

Parameters	Sym	Min	Тур	Max	Units	Conditions
Push-Pull Output						
High-Level Output Voltage	V <sub>OH</sub>	V <sub>DD</sub> -0.2	_	_	V	$I_{OUT} = -2 \text{ mA}, V_{DD} = 5V$
Low-Level Output Voltage	V <sub>OL</sub>	_	_	V <sub>SS</sub> +0.2	V	$I_{OUT} = 2 \text{ mA}, V_{DD} = 5V$
Short-Circuit Current	I <sub>SC</sub>	_	-2.5, +1.5	_	mA	V <sub>DD</sub> = 1.6V ( <b>Note 4</b> )
	I <sub>SC</sub>	_	±30	_	mA	V <sub>DD</sub> = 5.5V ( <b>Note 4</b> )

- Note 1: The input offset voltage is the center (average) of the input-referred trip points. The input hysteresis is the difference between the input-referred trip points.
  - 2: V<sub>HYST</sub> at different temperatures is estimated using V<sub>HYST</sub> (T<sub>A</sub>) = V<sub>HYST</sub> + (T<sub>A</sub> 25°C) TC<sub>1</sub> + (T<sub>A</sub> 25°C)<sup>2</sup> TC<sub>2</sub>.
  - 3: Input bias current at temperature is not tested for SC-70-5 package.
  - 4: Limit the output current to Absolute Maximum Rating of 30 mA.

### **AC CHARACTERISTICS**

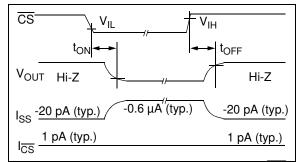
**Electrical Specifications:** Unless otherwise indicated,  $V_{DD} = +1.6V$  to +5.5V,  $V_{SS} = GND$ ,  $T_A = +25^{\circ}C$ ,  $V_{IN} + = V_{DD}/2$ , Step = 200 mV, Overdrive = 100 mV, and  $C_L = 36$  pF (Refer to Figure 1-2 and Figure 1-3).

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Parameters	Sym	Min	Тур	Max	Units	Conditions		
Rise Time	t <sub>R</sub>	_	0.85	_	μs			
Fall Time	t <sub>F</sub>	_	0.85	_	μs			
Propagation Delay (High-to-Low)	t <sub>PHL</sub>	_	4	8	μs			
Propagation Delay (Low-to-High)	t <sub>PLH</sub>	_	4	8	μs			
Propagation Delay Skew	t <sub>PDS</sub>	_	±0.2	_	μs	(Note 1)		
Maximum Toggle Frequency	f <sub>MAX</sub>	_	160	_	kHz	V <sub>DD</sub> = 1.6V		
	$f_{MAX}$	_	120	_	kHz	V <sub>DD</sub> = 5.5V		
Input Noise Voltage	E <sub>ni</sub>	_	200		$\mu V_{P-P}$	10 Hz to 100 kHz		

**Note 1:** Propagation Delay Skew is defined as:  $t_{PDS} = t_{PLH} - t_{PHL}$ .

## MCP6543 CHIP SELECT (CS) CHARACTERISTICS

Parameters	Sym	Min	Тур	Max	Units	Conditions
CS Low Specifications						
CS Logic Threshold, Low	V <sub>IL</sub>	$V_{SS}$	_	$0.2~\mathrm{V}_\mathrm{DD}$	V	
CS Input Current, Low	I <sub>CSL</sub>	_	5.0	_	рА	CS = V <sub>SS</sub>
CS High Specifications				•		
CS Logic Threshold, High	V <sub>IH</sub>	0.8 V <sub>D</sub>	_	V <sub>DD</sub>	V	
CS Input Current, High	I <sub>CSH</sub>	_	1	_	рА	CS = V <sub>DD</sub>
CS Input High, V <sub>DD</sub> Current	I <sub>DD</sub>	_	18	_	рА	CS = V <sub>DD</sub>
CS Input High, GND Current	I <sub>SS</sub>	_	-20	_	рА	$\overline{\text{CS}} = V_{\text{DD}}$
Comparator Output Leakage	I <sub>O(LEAK)</sub>	_	1	_	рА	$V_{OUT} = V_{DD}, \overline{CS} = V_{DD}$
CS Dynamic Specifications						
CS Low to Comparator Output Low Turn-on Time	t <sub>ON</sub>	_	2	50	ms	$\overline{\text{CS}}$ = 0.2 V <sub>DD</sub> to V <sub>OUT</sub> = V <sub>DD</sub> /2, V <sub>IN</sub> -= V <sub>DD</sub>
CS High to Comparator Output High Z Turn-off Time	t <sub>OFF</sub>		10	_	μs	$\overline{\overline{CS}}$ = 0.8 V <sub>DD</sub> to V <sub>OUT</sub> = V <sub>DD</sub> /2, V <sub>IN</sub> -= V <sub>DD</sub>
CS Hysteresis	V <sub>CS_HYS</sub>	_	0.6	_	V	V <sub>DD</sub> = 5V



**FIGURE 1-1:** Timing Diagram for the CS Pin on the MCP6543.

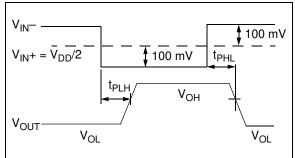


FIGURE 1-2: Propagation Delay Timing Diagram.

## **TEMPERATURE CHARACTERISTICS**

<b>Electrical Specifications:</b> Unless otherwise indicated, $V_{DD} = +1.6V$ to $+5.5V$ and $V_{SS} = GND$ .									
Parameters	Sym	Min	Тур	Max	Units	Conditions			
Temperature Ranges									
Specified Temperature Range	$T_A$	-40	_	+85	°C				
Operating Temperature Range	$T_A$	-40	_	+125	°C	Note			
Storage Temperature Range	$T_A$	-65	_	+150	°C				
Thermal Package Resistances									
Thermal Resistance, 5L-SC-70	$\theta_{\sf JA}$	_	331	_	°C/W				
Thermal Resistance, 5L-SOT-23	$\theta_{\sf JA}$	_	220.7	_	°C/W				
Thermal Resistance, 8L-PDIP	$\theta_{JA}$	_	89.3	_	°C/W				
Thermal Resistance, 8L-SOIC	$\theta_{\sf JA}$	_	149.5	_	°C/W				
Thermal Resistance, 8L-MSOP	$\theta_{\sf JA}$	_	211	_	°C/W				
Thermal Resistance, 14L-PDIP	$\theta_{JA}$	_	70	_	°C/W				
Thermal Resistance, 14L-SOIC	$\theta_{JA}$	_	95.3	_	°C/W				
Thermal Resistance, 14L-TSSOP	$\theta_{\sf JA}$		100	_	°C/W				

Note: The MCP6541/1R/1U/2/3/4 I-Temp parts operate over this extended temperature range, but with reduced performance. In any case, the Junction Temperature  $(T_J)$  must not exceed the Absolute Maximum specification of  $+150^{\circ}$ C.

## 1.1 Test Circuit Configuration

This test circuit configuration is used to determine the AC and DC specifications.

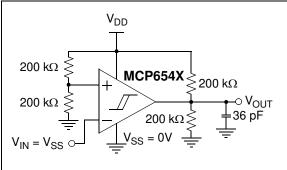
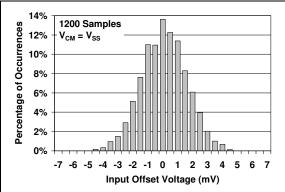


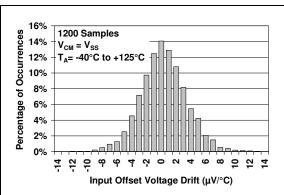
FIGURE 1-3: AC and DC Test Circuit for the Push-Pull Output Comparators.

#### 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



**FIGURE 2-1:** Input Offset Voltage at  $V_{CM} = V_{SS}$ .



**FIGURE 2-2:** Input Offset Voltage Drift at  $V_{CM} = V_{SS}$ .

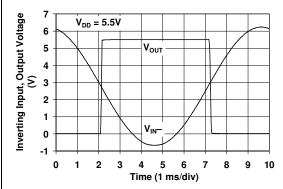
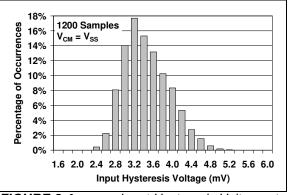
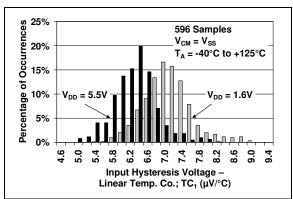


FIGURE 2-3: The MCP6541/1R/1U/2/3/4 Comparators Show No Phase Reversal.



**FIGURE 2-4:** Input Hysteresis Voltage at  $V_{CM} = V_{SS}$ .



**FIGURE 2-5:** Input Hysteresis Voltage Linear Temp. Co.  $(TC_1)$  at  $V_{CM} = V_{SS}$ .

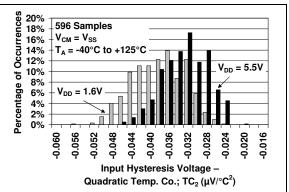
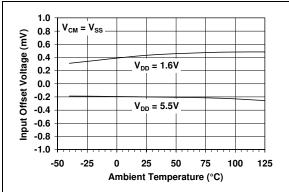
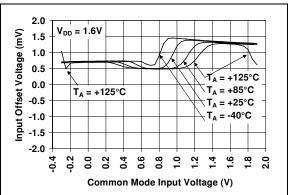


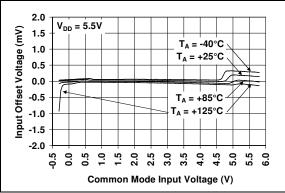
FIGURE 2-6: Input Hysteresis Voltage Quadratic Temp. Co. (TC<sub>2</sub>) at V<sub>CM</sub> = V<sub>SS</sub>.



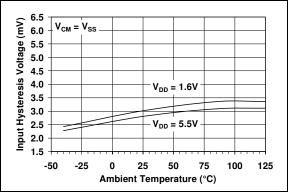
**FIGURE 2-7:** Input Offset Voltage vs. Ambient Temperature at  $V_{CM} = V_{SS}$ .



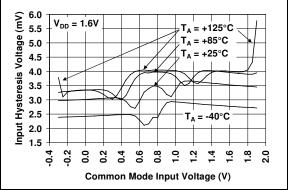
**FIGURE 2-8:** Input Offset Voltage vs. Common Mode Input Voltage at  $V_{DD} = 1.6V$ .



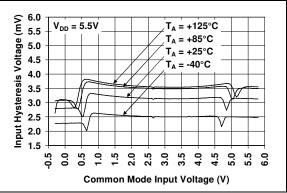
**FIGURE 2-9:** Input Offset Voltage vs. Common Mode Input Voltage at  $V_{DD} = 5.5V$ .



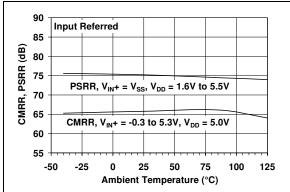
**FIGURE 2-10:** Input Hysteresis Voltage vs. Ambient Temperature at  $V_{CM} = V_{SS}$ .



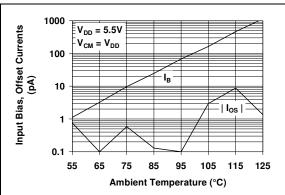
**FIGURE 2-11:** Input Hysteresis Voltage vs. Common Mode Input Voltage at  $V_{DD} = 1.6V$ .



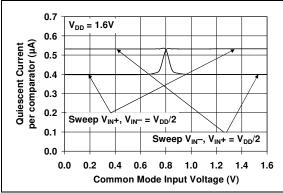
**FIGURE 2-12:** Input Hysteresis Voltage vs. Common Mode Input Voltage at  $V_{DD} = 5.5V$ .



**FIGURE 2-13:** CMRR, PSRR vs. Ambient Temperature.



**FIGURE 2-14:** Input Bias Current, Input Offset Current vs. Ambient Temperature.



**FIGURE 2-15:** Quiescent Current vs. Common Mode Input Voltage at  $V_{DD} = 1.6V$ .

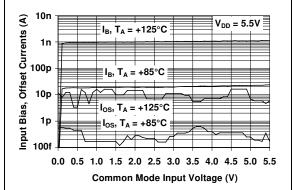
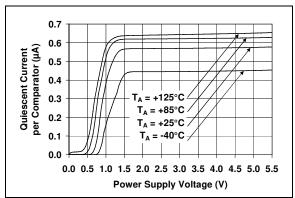
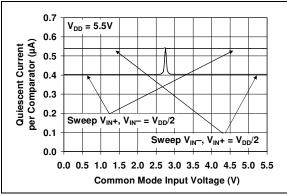


FIGURE 2-16: Input Bias Current, Input Offset Current vs. Common Mode Input Voltage.



**FIGURE 2-17:** Quiescent Current vs. Power Supply Voltage.



**FIGURE 2-18:** Quiescent Current vs. Common Mode Input Voltage at  $V_{DD} = 5.5V$ .

**Note:** Unless otherwise indicated,  $V_{DD}$  = +1.6V to +5.5V,  $V_{SS}$  = GND,  $T_A$  = +25°C,  $V_{IN}$ + =  $V_{DD}$ /2,  $V_{IN}$ - = GND,  $R_L$  = 100 k $\Omega$  to  $V_{DD}$ /2, and  $C_L$  = 36 pF.

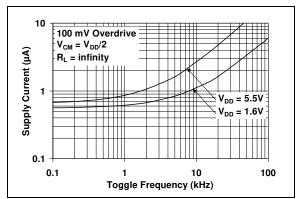
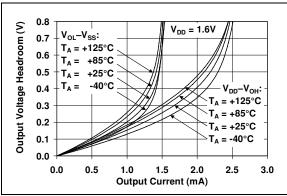


FIGURE 2-19: Frequency.

Supply Current vs. Toggle



**FIGURE 2-20:** Output Voltage Headroom vs. Output Current at  $V_{DD} = 1.6V$ .

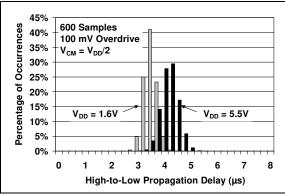


FIGURE 2-21: Delay.

High-to-Low Propagation

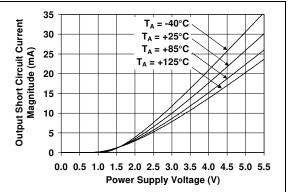
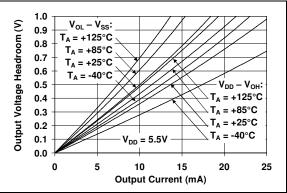
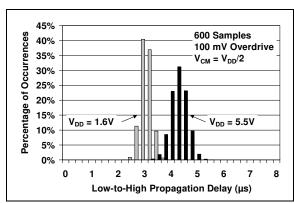


FIGURE 2-22: Output Short Circuit Current Magnitude vs. Power Supply Voltage.



**FIGURE 2-23:** Output Voltage Headroom vs. Output Current at  $V_{DD} = 5.5V$ .



**FIGURE 2-24:** 

Low-to-High Propagation

Delay.

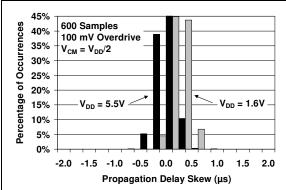


FIGURE 2-25: Propagation Delay Skew.

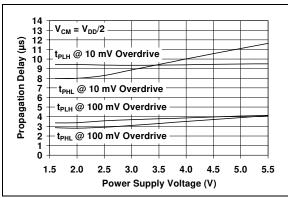
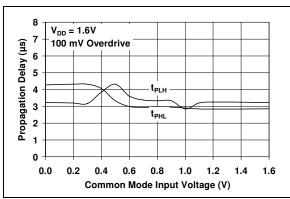
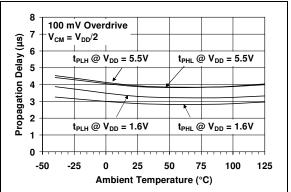


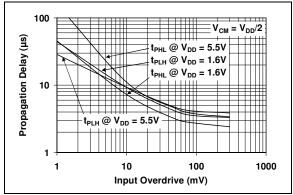
FIGURE 2-26: Propagation Delay vs. Power Supply Voltage.



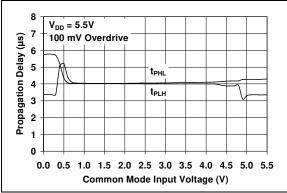
**FIGURE 2-27:** Propagation Delay vs. Common Mode Input Voltage at  $V_{DD} = 1.6V$ .



**FIGURE 2-28:** Propagation Delay vs. Ambient Temperature.



**FIGURE 2-29:** Propagation Delay vs. Input Overdrive.



**FIGURE 2-30:** Propagation Delay vs. Common Mode Input Voltage at  $V_{DD} = 5.5V$ .

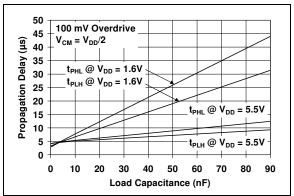
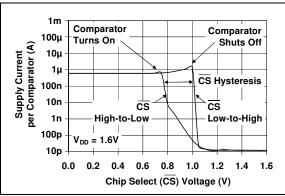
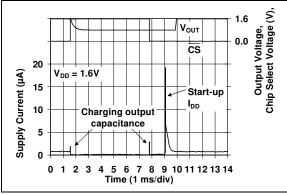


FIGURE 2-31: Propagation Delay vs. Load Capacitance.



**FIGURE 2-32:** Supply Current (shoot through current) vs. Chip Select ( $\overline{CS}$ ) Voltage at  $V_{DD} = 1.6V$  (MCP6543 only).



**FIGURE 2-33:** Supply Current (charging current) vs. Chip Select (CS) pulse at  $V_{DD} = 1.6V$  (MCP6543 only).

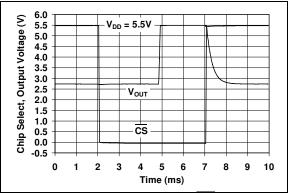
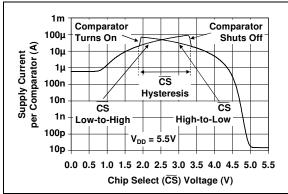
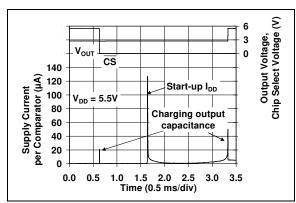


FIGURE 2-34: Chip Select (CS) Step Response (MCP6543 only).



**FIGURE 2-35:** Supply Current (shoot through current) vs. Chip Select ( $\overline{CS}$ ) Voltage at  $V_{DD} = 5.5V$  (MCP6543 only).



**FIGURE 2-36:** Supply Current (charging current) vs. Chip Select (CS) pulse at  $V_{DD} = 5.5V$  (MCP6543 only).

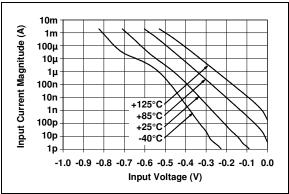


FIGURE 2-37: Input Bias Current vs. Input Voltage.

**NOTES:** 

#### 3.0 PIN DESCRIPTIONS

Descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

MCP6541 PDIP, SOIC, MSOP	MCP6541 SOT-23-5, SC-70-5	MCP6541R	MCP6541U SOT-23-5 SC-70-5	MCP6542	MCP6543	MCP6544	Symbol	Description
6	1	1	4	1	6	1	OUT, OUTA	Digital Output (comparator A)
2	4	4	3	2	2	2	V <sub>IN</sub> -, V <sub>INA</sub> -	Inverting Input (comparator A)
3	3	3	1	3	3	3	$V_{IN}^{+}, V_{INA}^{+}$	Non-inverting Input (comparator A)
7	5	2	5	8	7	4	$V_{DD}$	Positive Power Supply
_	_	_	_	5	_	5	V <sub>INB</sub> +	Non-inverting Input (comparator B)
_	_	_	_	6	_	6	V <sub>INB</sub> -	Inverting Input (comparator B)
_	_	_	_	7	_	7	OUTB	Digital Output (comparator B)
_	_	_	_	_	_	8	OUTC	Digital Output (comparator C)
_	_	_	_	_	_	9	V <sub>INC</sub> -	Inverting Input (comparator C)
_	_	_	_	_	_	10	V <sub>INC</sub> +	Non-inverting Input (comparator C)
4	2	5	2	4	4	11	$V_{SS}$	Negative Power Supply
_	_	_	_	_	_	12	V <sub>IND</sub> +	Non-inverting Input (comparator D)
_	_	_	_	_	_	13	V <sub>IND</sub> -	Inverting Input (comparator D)
_	_	_	_	_	_	14	OUTD	Digital Output (comparator D)
_	_	_	_	_	8	_	CS	Chip Select
1, 5, 8	_	_	_	_	1, 5	_	NC	No Internal Connection

### 3.1 Analog Inputs

The comparator non-inverting and inverting inputs are high-impedance CMOS inputs with low bias currents.

## 3.2 CS Digital Input

This is a CMOS, Schmitt-triggered input that places the part into a low-power mode of operation.

### 3.3 Digital Outputs

The comparator outputs are CMOS, push-pull digital outputs. They are designed to be compatible with CMOS and TTL logic and are capable of driving heavy DC or capacitive loads.

## 3.4 Power Supply (V<sub>SS</sub> and V<sub>DD</sub>)

The positive power supply pin ( $V_{DD}$ ) is 1.6V to 5.5V higher than the negative power supply pin ( $V_{SS}$ ). For normal operation, the other pins are at voltages between  $V_{SS}$  and  $V_{DD}$ .

Typically, these parts are used in a single (positive) supply configuration. In this case,  $V_{SS}$  is connected to ground and  $V_{DD}$  is connected to the supply.  $V_{DD}$  will need a local bypass capacitor (typically 0.01  $\mu F$  to 0.1  $\mu F)$  within 2 mm of the  $V_{DD}$  pin. These can share a bulk capacitor with nearby analog parts (within 100 mm), but it is not required.

**NOTES:** 

#### 4.0 APPLICATIONS INFORMATION

The MCP6541/1R/1U/2/3/4 family of push-pull output comparators are fabricated on Microchip's state-of-theart CMOS process. They are suitable for a wide range of applications requiring very low-power consumption.

### 4.1 Comparator Inputs

#### 4.1.1 PHASE REVERSAL

The MCP6541/1R/1U/2/3/4 comparator family uses CMOS transistors at the input. They are designed to prevent phase inversion when the input pins exceed the supply voltages. Figure 2-3 shows an input voltage exceeding both supplies with no resulting phase inversion.

# 4.1.2 INPUT VOLTAGE AND CURRENT LIMITS

The ESD protection on the inputs can be depicted as shown in Figure 4-1. This structure was chosen to protect the input transistors, and to minimize input bias current (IB). The input ESD diodes clamp the inputs when they try to go more than one diode drop below  $V_{SS}.$  They also clamp any voltages that go too far above  $V_{DD};$  their breakdown voltage is high enough to allow normal operation, and low enough to bypass ESD events within the specified limits.

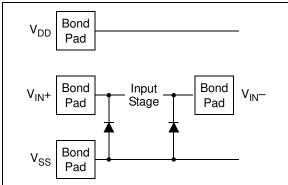


FIGURE 4-1: Simplified Analog Input ESD Structures.

In order to prevent damage and/or improper operation of these amplifiers, the circuits they are in must limit the currents (and voltages) at the  $V_{IN^+}$  and  $V_{IN^-}$  pins (see Absolute Maximum Ratings  $\dagger$  at the beginning of Section 1.0 "Electrical Characteristics"). Figure 4-3 shows the recommended approach to protecting these inputs. The internal ESD diodes prevent the input pins  $(V_{IN^+}$  and  $V_{IN^-})$  from going too far below ground, and the resistors  $R_1$  and  $R_2$ , limit the possible current drawn out of the input pin. Diodes  $D_1$  and  $D_2$  prevent the input pin  $(V_{IN^+}$  and  $V_{IN^-})$  from going too far above  $V_{DD}$ . When implemented as shown, resistors  $R_1$  and  $R_2$  also limit the current through  $D_1$  and  $D_2$ .

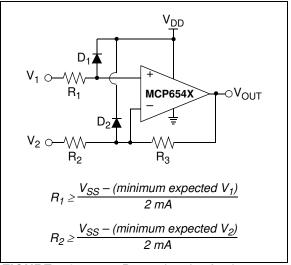


FIGURE 4-2: Protecting the Analog Inputs.

It is also possible to connect the diodes to the left of the resistors  $\mathsf{R}_1$  and  $\mathsf{R}_2.$  In this case, the currents through the diodes  $\mathsf{D}_1$  and  $\mathsf{D}_2$  need to be limited by some other mechanism. The resistor then serves as in-rush current limiter; the DC current into the input pins (V<sub>IN</sub>+ and V<sub>IN</sub>-) should be very small.

A significant amount of current can flow out of the inputs when the common mode voltage ( $V_{CM}$ ) is below ground ( $V_{SS}$ ); see Figure 2-37. Applications that are high-impedance may need to limit the usable voltage range.

#### 4.1.3 NORMAL OPERATION

The input stage of this family of devices uses two differential input stages in parallel: one operates at low input voltages and the other at high input voltages. With this topology, the input voltage is 0.3V above  $V_{DD}$  and 0.3V below  $V_{SS}.$  Therefore, the input offset voltage is measured at both  $V_{SS}$  - 0.3V and  $V_{DD}$  + 0.3V to ensure proper operation.

The MCP6541/1R/1U/2/3/4 family has internally-set hysteresis that is small enough to maintain input offset accuracy (<7 mV) and large enough to eliminate output chattering caused by the comparator's own input noise voltage (200  $\mu$ V<sub>p-p</sub>). Figure 4-3 depicts this behavior.

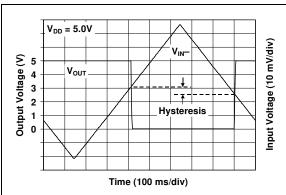


FIGURE 4-3: The MCP6541/1R/1U/2/3/4 comparators' internal hysteresis eliminates output chatter caused by input noise voltage.

## 4.2 Push-Pull Output

The push-pull output is designed to be compatible with CMOS and TTL logic, while the output transistors are configured to give rail-to-rail output performance. They are driven with circuitry that minimizes any switching current (shoot-through current from supply-to-supply) when the output is transitioned from high-to-low, or from low-to-high (see Figures 2-15, 2-18, and 2-32 — 2-36 for more information).

## 4.3 MCP6543 Chip Select (CS)

The MCP6543 is a single comparator with Chip Select ( $\overline{CS}$ ). When  $\overline{CS}$  is pulled high, the total current consumption drops to 20 pA (typ.); 1 pA (typ.) flows through the  $\overline{CS}$  pin, 1 pA (typ.) flows through the output pin and 18 pA (typ.) flows through the V<sub>DD</sub> pin, as shown in Figure 1-1. When this happens, the comparator output is put into a high-impedance state. By pulling  $\overline{CS}$  low, the comparator is enabled. If the  $\overline{CS}$  pin is left floating, the comparator will not operate properly. Figure 1-1 shows the output voltage and supply current response to a  $\overline{CS}$  pulse.

The internal  $\overline{\text{CS}}$  circuitry is designed to minimize glitches when cycling the  $\overline{\text{CS}}$  pin. This helps conserve power, which is especially important in battery-powered applications.

#### 4.4 Externally Set Hysteresis

Greater flexibility in selecting hysteresis (or input trip points) is achieved by using external resistors.

Input offset voltage ( $V_{OS}$ ) is the center (average) of the (input-referred) low-high and high-low trip points. Input hysteresis voltage ( $V_{HYST}$ ) is the difference between the same trip points. Hysteresis reduces output chattering when one input is slowly moving past the other and thus reduces dynamic supply current. It also helps in systems where it is best not to cycle between states too frequently (e.g., air conditioner thermostatic control).

#### 4.4.1 NON-INVERTING CIRCUIT

Figure 4-4 shows a non-inverting circuit for singlesupply applications using just two resistors. The resulting hysteresis diagram is shown in Figure 4-5.

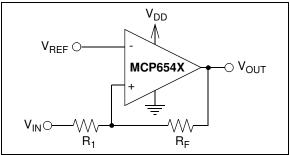


FIGURE 4-4: Non-inverting Circuit with Hysteresis for Single-supply.

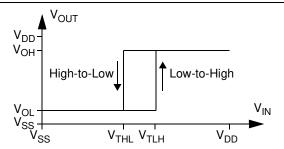


FIGURE 4-5: Hysteresis Diagram for the Non-Inverting Circuit.

The trip points for Figures 4-4 and 4-5 are:

#### **EQUATION 4-1:**

$$\begin{split} V_{TLH} &= V_{REF} \bigg( I + \frac{R_I}{R_F} \bigg) - V_{OL} \bigg( \frac{R_I}{R_F} \bigg) \\ V_{THL} &= V_{REF} \bigg( I + \frac{R_I}{R_F} \bigg) - V_{OH} \bigg( \frac{R_I}{R_F} \bigg) \end{split}$$

 $V_{TLH}$  = trip voltage from low-to-high  $V_{THL}$  = trip voltage from high-to-low

#### 4.4.2 INVERTING CIRCUIT

Figure 4-6 shows an inverting circuit for single-supply using three resistors. The resulting hysteresis diagram is shown in Figure 4-7.

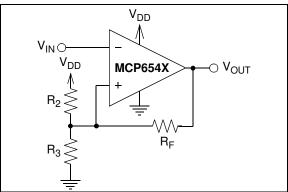


FIGURE 4-6: Inverting Circuit With Hysteresis.

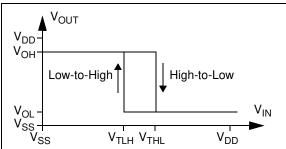


FIGURE 4-7: Hysteresis Diagram for the Inverting Circuit.

In order to determine the trip voltages ( $V_{THL}$  and  $V_{TLH}$ ) for the circuit shown in Figure 4-6,  $R_2$  and  $R_3$  can be simplified to the Thevenin equivalent circuit with respect to  $V_{DD}$ , as shown in Figure 4-8.

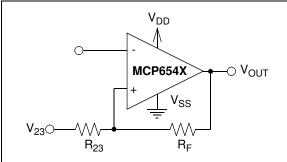


FIGURE 4-8: Thevenin Equivalent Circuit.

Where:

$$R_{23} = \frac{R_2 R_3}{R_2 + R_3}$$

$$V_{23} = \frac{R_3}{R_2 + R_3} \times V_{DD}$$

Using this simplified circuit, the trip voltage can be calculated using the following equation:

#### **EQUATION 4-2:**

$$\begin{split} V_{THL} &= V_{OH} \bigg( \frac{R_{23}}{R_{23} + R_F} \bigg) + V_{23} \bigg( \frac{R_F}{R_{23} + R_F} \bigg) \\ V_{TLH} &= V_{OL} \bigg( \frac{R_{23}}{R_{23} + R_F} \bigg) + V_{23} \bigg( \frac{R_F}{R_{23} + R_F} \bigg) \end{split}$$

 $V_{TIH}$  = trip voltage from low-to-high

 $V_{THL}$  = trip voltage from high-to-low

Figure 2-20 and Figure 2-23 can be used to determine typical values for  $V_{OH}$  and  $V_{OL}$ .

#### 4.5 Bypass Capacitors

With this family of comparators, the power supply pin ( $V_{DD}$  for single supply) should have a local bypass capacitor (i.e., 0.01  $\mu$ F to 0.1  $\mu$ F) within 2 mm for good edge rate performance.

### 4.6 Capacitive Loads

Reasonable capacitive loads (e.g., logic gates) have little impact on propagation delay (see Figure 2-31). The supply current increases with increasing toggle frequency (Figure 2-19), especially with higher capacitive loads.

#### 4.7 Battery Life

In order to maximize battery life in portable applications, use large resistors and small capacitive loads. Avoid toggling the output more than necessary. Do not use Chip Select  $\overline{(CS)}$  frequently to conserve start-up power. Capacitive loads will draw additional power at start-up.

#### 4.8 PCB Surface Leakage

In applications where low input bias current is critical, PCB (Printed Circuit Board) surface leakage effects need to be considered. Surface leakage is caused by humidity, dust or other contamination on the board. Under low humidity conditions, a typical resistance between nearby traces is  $10^{12}\Omega$ . A 5V difference would cause 5 pA of current to flow. This is greater than the MCP6541/1R/1U/2/3/4 family's bias current at 25°C (1 pA, typ.).

The easiest way to reduce surface leakage is to use a guard ring around sensitive pins (or traces). The guard ring is biased at the same voltage as the sensitive pin. An example of this type of layout is shown in Figure 4-9.

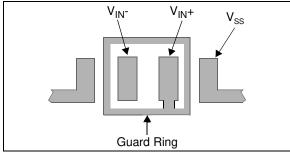


FIGURE 4-9: Example Guard Ring Layout for Inverting Circuit.

- 1. Inverting Configuration (Figures 4-6 and 4-9):
  - a.Connect the guard ring to the non-inverting input pin  $(V_{IN}+)$ . This biases the guard ring to the same reference voltage as the comparator (e.g.,  $V_{DD}/2$  or ground).
  - b.Connect the inverting pin  $(V_{IN}-)$  to the input pad without touching the guard ring.
- 2. Non-inverting Configuration (Figure 4-4):
  - a.Connect the non-inverting pin (V<sub>IN</sub>+) to the input pad without touching the guard ring.
  - b.Connect the guard ring to the inverting input pin  $(V_{IN}-)$ .

#### 4.9 Unused Comparators

An unused amplifier in a quad package (MCP6544) should be configured as shown in Figure 4-10. This circuit prevents the output from toggling and causing crosstalk. It uses the minimum number of components and draws minimal current (see Figure 2-15 and Figure 2-18).

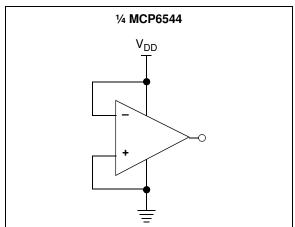
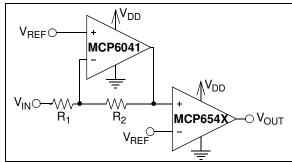


FIGURE 4-10: Unused Comparators.

### 4.10 Typical Applications

#### 4.10.1 PRECISE COMPARATOR

Some applications require higher DC precision. An easy way to solve this problem is to use an amplifier (such as the MCP6041) to gain-up the input signal before it reaches the comparator. Figure 4-11 shows an example of this approach.



**FIGURE 4-11:** Precise Inverting Comparator.

#### 4.10.2 WINDOWED COMPARATOR

Figure 4-12 shows one approach to designing a windowed comparator. The AND gate produces a logic '1' when the input voltage is between  $V_{RB}$  and  $V_{RT}$  (where  $V_{RT} > V_{RB}$ ).

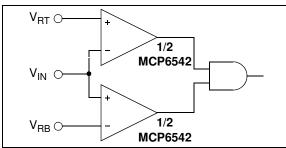
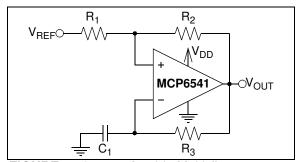


FIGURE 4-12: Windowed Comparator.

#### 4.10.3 ASTABLE MULTIVIBRATOR

A simple astable multivibrator design is shown in Figure 4-13.  $V_{REF}$  needs to be between the power supplies ( $V_{SS}$  = GND and  $V_{DD}$ ) to achieve oscillation. The output duty cycle changes with  $V_{REF}$ 



#### 5.0 PACKAGING INFORMATION

## 5.1 Package Marking Information

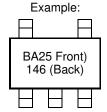




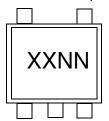
Device	I-Temp Code	E-Temp Code		
MCP6541T-I/LT	ABNN	Note 2		
MCP6541UT-I/LT	BANN	Note 2		

Note 1: I-Temp parts prior to March 2005 are marked "BAN"

2: SC-70-5 E-Temp parts not available at this release of this data sheet.

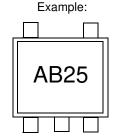


#### 5-Lead SOT-23 (MCP6541, MCP6541R, MCP6541U)

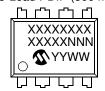


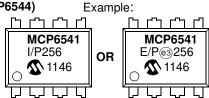
Device	I-Temp Code	E-Temp Code
MCP6541	ABNN	GTNN
MCP6541R	AGNN	GUNN
MCP6541U	_	ATNN

Note: Applies to 5-Lead SOT-23

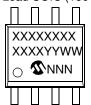


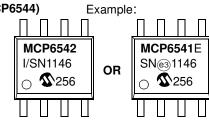
#### 8-Lead PDIP (300 mil) (MCP6541, MCP6542, MCP6543, MCP6544)





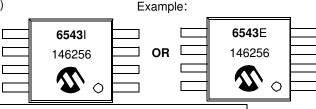
8-Lead SOIC (150 mil) (MCP6541, MCP6542, MCP6543, MCP6544)





8-Lead MSOP (MCP6541, MCP6542, MCP6543)





Legend: XX...X Customer-specific information
Year code (last digit of calendary)

Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

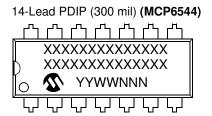
NNN Alphanumeric traceability code

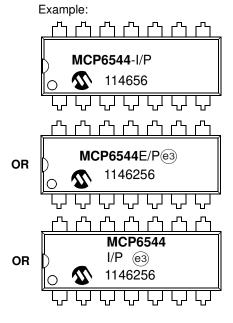
e3 Pb-free JEDEC designator for Matte Tin (Sn)

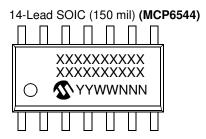
This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

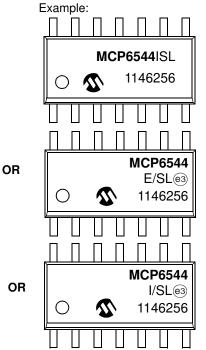
**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

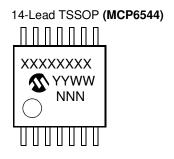
### **Package Marking Information (Continued)**

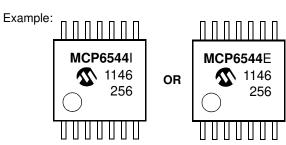






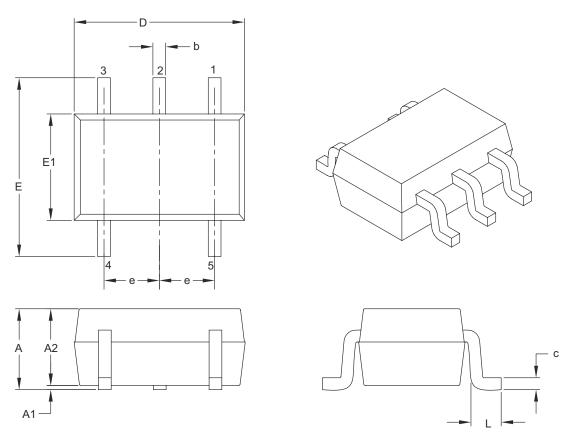






## 5-Lead Plastic Small Outline Transistor (LT) [SC70]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
Dime	nsion Limits	MIN	NOM	MAX	
Number of Pins	N		5		
Pitch	е		0.65 BSC		
Overall Height	А	0.80	_	1.10	
Molded Package Thickness	A2	0.80	_	1.00	
Standoff	A1	0.00	_	0.10	
Overall Width	E	1.80	2.10	2.40	
Molded Package Width	E1	1.15	1.25	1.35	
Overall Length	D	1.80	2.00	2.25	
Foot Length	L	0.10	0.20	0.46	
Lead Thickness	С	0.08	_	0.26	
Lead Width	b	0.15	_	0.40	

### Notes:

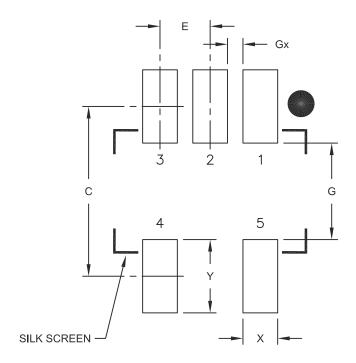
- 1. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.127 mm per side.
- 2. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-061B

## 5-Lead Plastic Small Outline Transistor (LT) [SC70]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units	MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX	
Contact Pitch	E		0.65 BSC		
Contact Pad Spacing	С		2.20		
Contact Pad Width	Х			0.45	
Contact Pad Length	Υ			0.95	
Distance Between Pads	G	1.25			
Distance Between Pads	Gx	0.20			

#### Notes:

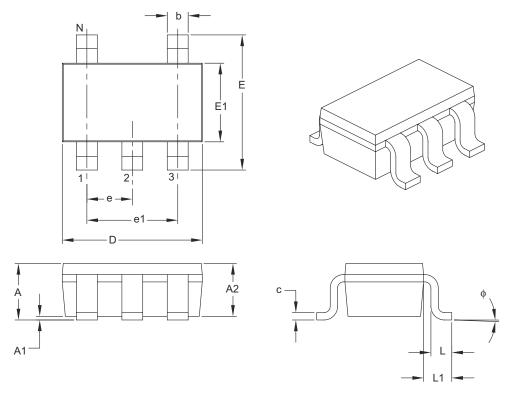
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2061A

## 5-Lead Plastic Small Outline Transistor (OT) [SOT-23]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS			
	Dimension Limits	MIN	NOM	MAX		
Number of Pins	N		5	•		
Lead Pitch	е		0.95 BSC			
Outside Lead Pitch	e1		1.90 BSC			
Overall Height	A	0.90	-	1.45		
Molded Package Thickness	A2	0.89	_	1.30		
Standoff	A1	0.00	_	0.15		
Overall Width	E	2.20	_	3.20		
Molded Package Width	E1	1.30	_	1.80		
Overall Length	D	2.70	_	3.10		
Foot Length	L	0.10	_	0.60		
Footprint	L1	0.35	_	0.80		
Foot Angle	ф	0°	_	30°		
Lead Thickness	С	0.08	_	0.26		
Lead Width	b	0.20	_	0.51		

#### Notes:

- 1. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.127 mm per side.
- 2. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-091B